

## 74F456 <br> Octal buffer/driver with parity, non-inverting (3-State)

Product specification
Supersedes data of 1999 Jan 08
IC15 Data Handbook

## FEATURES

- High impedance NPN base inputs for reduced loading ( $40 \mu \mathrm{~A}$ in High and Low states)
- 74F456 combines 74F244 and 74F280A functions in one package
- 74 F 456 is a center pin version of the 74 F 656 A
- Non-Inverting
- 3-State outputs sink 64 mA and source 15 mA
- 24-pin plastic Slim DIP (300 mil) package
- Broadside pinout simplifies PC board layout


## DESCRIPTION

The 74F456 is an octal buffer and line driver with parity generation/checking designed to be employed as memory address drivers, clock drivers and bus-oriented transmitters/receivers. These parts include parity generator/checker to improve PC board density.

| TYPE | TYPICAL <br> PROPAGATION <br> DELAY | TYPICAL SUPPLY CURRENT <br> (TOTAL) |
| :---: | :---: | :---: |
| 74 F 456 | 7.5 ns | 64 mA |

ORDERING INFORMATION

| DESCRIPTION | COMMERCIAL <br> RANGE <br> $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \pm 10 \%$, <br> $\mathrm{T}_{\mathrm{amb}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | PKG DWG \# |
| :---: | :---: | :---: |
| 24-pin plastic Slim <br> DIP (300mil) | N74F456N | SOT222-1 |
| 24-pin plastic SOL | N74F456D | SOT137-1 |

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

| PINS | DESCRIPTION | 74F(U.L.) <br> HIGH/LOW | LOAD VALUE <br> HIGH/LOW |
| :--- | :--- | :---: | :---: |
| D0-D7 | Data inputs | $2.0 / 0.066$ | $40 \mu \mathrm{~A} / 40 \mu \mathrm{~A}$ |
| PI | Parity input | $1.0 / 0.033$ | $20 \mu \mathrm{~A} / 20 \mu \mathrm{~A}$ |
| $\overline{\text { OE0, OE1 }}$ | Output Enable inputs (active Low) | $1.0 / 0.033$ | $20 \mu \mathrm{~A} / 20 \mu \mathrm{~A}$ |
| EE, LO | Parity outputs | $750 / 106.7$ | $15 \mathrm{~mA} / 64 \mathrm{~mA}$ |
| Q0-Q7 | Data outputs | $750 / 106.7$ | $15 \mathrm{~mA} / 64 \mathrm{~mA}$ |

NOTE: One (1.0) FAST Unit Load (U.L.) is defined as $20 \mu \mathrm{~A}$ in the High state and 0.6 mA in the Low state.

PIN CONFIGURATION


LOGIC SYMBOL


LOGIC SYMBOL (IEEE/IEC)

| 3 | P3 |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  |  | $3,5,6,7,8$$9,10,11,12$$\quad[$ EVEN $] \nabla$ |  | 23 |
|  |  |  |  |  |
|  |  | $\begin{array}{\|ll} 3,5,6,7,8 \\ 9,10,11,12 \end{array} \quad[\text { ODD }] \nabla$ |  | 24 |
|  |  |  |  |  |
| 1 N | $\geqslant 1$ |  |  |  |
| 2 N |  | EN4 |  |  |
|  |  |  | $\square$ |  |
| 4 | Z5 |  | $4 \nabla$ | 22 |
| 5 | Z6 |  |  | 21 |
| 6 | Z7 |  |  | 20 |
| 8 | Z8 |  |  | 17 |
| 9 | Z9 |  |  | 16 |
| 10 | Z10 |  |  | 15 |
| 11 | Z11 |  |  | 14 |
| 12 | Z12 |  |  | 13 |
|  |  |  |  |  |

## FUNCTION TABLE

| INPUTS |  |  | OUTPUTS |
| :---: | :---: | :---: | :---: |
| $\overline{\text { OE0 }}$ | $\overline{\text { OE1 }}$ | Dn | Qn |
| L | L | L | L |
| L | L | H | H |
| H | X | X | Z |
| X | H | X | Z |

[^0]FUNCTION TABLE for PARITY OUTPUTS

| INPUTS | OUTPUTS |  |
| :--- | :---: | :---: |
| Number of inputs, High (PI, D0 - D7) | $\Sigma \mathrm{E}$ | $\Sigma \mathrm{O}$ |
| Even $-0,2,4,6,8$ | H | L |
| Odd - 1, 3, 5, 7, 9 | L | H |
| Any $\overline{\text { OEn }=\text { High }}$ | Z | Z |

[^1]

## ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free-air temperature range.)

| SYMBOL | PARAMETER | RATING | UNIT |
| :--- | :--- | :---: | :---: |
| $\mathrm{V}_{\text {CC }}$ | Supply voltage | -0.5 to +7.0 | V |
| $\mathrm{~V}_{\text {IN }}$ | Input voltage | -0.5 to +7.0 | V |
| $\mathrm{I}_{\mathrm{N}}$ | Input current | -30 to +5 | mA |
| $\mathrm{~V}_{\text {OUT }}$ | Voltage applied to output in High output state | -0.5 to $+\mathrm{V}_{\mathrm{CC}}$ | V |
| $\mathrm{I}_{\text {OUT }}$ | Current applied to output in Low output state | 128 | mA |
| $\mathrm{~T}_{\text {amb }}$ | Operating free-air temperature range | 0 to +70 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | LIMITS |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | NOM | MAX |  |
| $\mathrm{V}_{\text {cc }}$ | Supply voltage | 4.5 | 5.0 | 5.5 | V |
| $\mathrm{V}_{1 \mathrm{H}}$ | High-level input voltage | 2.0 |  |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage |  |  | 0.8 | V |
| IIK | Input clamp current |  |  | -18 | mA |
| IOH | High-level output current |  |  | -15 | mA |
| IOL | Low-level output current |  |  | 64 | mA |
| $\mathrm{T}_{\text {amb }}$ | Operating free-air temperature range | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

## DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

| SYMBOL | PARAMETER |  | TEST CONDITIONS ${ }^{1}$ |  |  | LIMITS |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP ${ }^{2}$ | MAX |  |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage |  |  |  |  | $\begin{aligned} & V_{C C}=M I N, \\ & V_{I L}=M A X, \\ & V_{I H}=M I N \end{aligned}$ | $\mathrm{I}_{\mathrm{OH}}=-3 \mathrm{~mA}$ | $\pm 10 \% \mathrm{~V}_{\mathrm{CC}}$ | 2.4 |  |  | V |
|  |  |  | $\pm 5 \% \mathrm{~V}_{\text {cc }}$ | 2.7 | 3.3 |  |  |  | V |
|  |  |  | $\mathrm{IOH}^{\prime}=-15 \mathrm{~mA}$ | $\pm 10 \% \mathrm{~V}_{\text {CC }}$ | 2.0 |  |  |  | V |
| $\mathrm{V}_{\text {OL }}$ | Low-level output voltage |  | $\mathrm{V}_{\text {CC }}=\mathrm{MIN}$, |  | $\pm 10 \% \mathrm{~V}_{\mathrm{CC}}$ |  |  | 0.55 | V |
|  |  |  | $\mathrm{V}_{1 \mathrm{H}}=$ | $L=M A X$ | $\pm 5 \% \mathrm{~V}_{\text {cc }}$ |  | 0.42 | 0.55 | V |
| $\mathrm{V}_{\mathrm{IK}}$ | Input clamp voltage |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{I}$ | $\mathrm{I}_{\mathrm{IK}}$ |  |  | -0.73 | -1.2 | V |
| I | Input current at maximum input voltage |  | $\mathrm{V}_{\mathrm{CC}}=0.0 \mathrm{~V}, \mathrm{~V}_{1}$ | $=7.0 \mathrm{~V}$ |  |  |  | 100 | $\mu \mathrm{A}$ |
| ${ }_{1} \mathrm{H}$ | High-level input current | Dn | $V_{C C}=M A X, V_{1}=2.7 \mathrm{~V}$ |  |  |  |  | 40 | $\mu \mathrm{A}$ |
|  |  | PI, OEn |  |  |  |  |  | 20 | $\mu \mathrm{A}$ |
| I/L | Low-level input current | Dn | $V_{C C}=M A X, V_{1}=0.5 \mathrm{~V}$ |  |  |  |  | -40 | $\mu \mathrm{A}$ |
|  |  | PI, OEn |  |  |  |  |  | -20 | $\mu \mathrm{A}$ |
| l OzH | Off-state output current High-level voltage applied |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$, | $\mathrm{O}=2.7 \mathrm{~V}$ |  |  |  | 50 | $\mu \mathrm{A}$ |
| IozL | Off-state output current Low-level voltage applied |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ |  |  |  |  | -50 | $\mu \mathrm{A}$ |
| los | Short-circuit output current ${ }^{3}$ |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$ |  |  | -100 |  | -225 | mA |
| ${ }^{\text {Icc }}$ | Supply current (total) | $\mathrm{I}_{\mathrm{CCH}}$ | $V_{C C}=\mathrm{MAX}$ |  |  |  | 50 | 80 | mA |
|  |  | $\mathrm{I}_{\text {CCL }}$ |  |  |  |  | 78 | 110 | mA |
|  |  | ICCZ |  |  |  |  | 63 | 90 | mA |

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
2. All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\text {amb }}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time. For testing los, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, los tests should be performed last.

## AC ELECTRICAL CHARACTERISTICS

| SYMBOL | PARAMETER | TEST CONDITION | LIMITS |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \\ \mathrm{~T}_{\text {amb }}=+25^{\circ} \mathrm{C} \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega \end{gathered}$ |  |  | $\begin{gathered} \mathrm{V}_{\mathrm{Cc}}=+5 \mathrm{~V} \pm 10 \% \\ \mathrm{~T}_{\mathrm{amb}}=0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega \end{gathered}$ |  |  |
|  |  |  | MIN | TYP | MAX | MIN | MAX |  |
| $\begin{aligned} & \text { tpLH } \\ & t_{\text {tPHL }} \end{aligned}$ | Propagation delay Dn to Qn | Waveform 1 | $\begin{aligned} & 2.0 \\ & 2.5 \end{aligned}$ | $\begin{aligned} & 4.5 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & 6.5 \\ & 7.0 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 2.5 \end{aligned}$ | $\begin{aligned} & 7.0 \\ & 7.5 \end{aligned}$ | ns |
| $\begin{aligned} & \mathrm{tpLH}^{\text {tpHL }} \\ & \mathrm{t}_{\mathrm{PHL}} \end{aligned}$ | Propagation delay <br> Dn to $\Sigma \mathrm{E}, \Sigma \mathrm{O}$ | Waveform 1, 2 | $\begin{aligned} & 5.5 \\ & 5.5 \end{aligned}$ | $\begin{aligned} & 10.0 \\ & 11.0 \end{aligned}$ | $\begin{aligned} & 13.0 \\ & 14.5 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 5.5 \end{aligned}$ | $\begin{aligned} & 14.0 \\ & 16.5 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpZH } \\ & \text { tpzL } \end{aligned}$ | Output Enable time to High or Low level | Waveform 3 <br> Waveform 4 | $\begin{aligned} & 2.5 \\ & 4.0 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 8.0 \end{aligned}$ | $\begin{aligned} & 8.0 \\ & 10.5 \end{aligned}$ | $\begin{aligned} & 2.5 \\ & 4.0 \end{aligned}$ | $\begin{gathered} 9.0 \\ 11.5 \end{gathered}$ | ns |
| $\begin{aligned} & \text { tpHz } \\ & \text { tplz } \end{aligned}$ | Output Disable time from High or Low level | Waveform 3 Waveform 4 | $\begin{aligned} & 1.5 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & 6.5 \\ & 7.5 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & \hline 7.5 \\ & 8.0 \end{aligned}$ | ns |

## AC WAVEFORMS

For all waveforms, $\mathrm{V}_{\mathrm{M}}=1.5 \mathrm{~V}$.


Waveform 1. Propagation Delay, Non-Inverting Outputs


Waveform 3. 3-State Output Enable Time to High Level and Output Disable Time from High Level


Waveform 2. Propagation Delay, Inverting Outputs


Waveform 4. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

## TEST CIRCUIT AND WAVEFORMS




DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

| UNIT | $\mathbf{A}$ <br> $\mathbf{m a x}$. | $\mathbf{A}_{\mathbf{1}}$ <br> $\mathbf{m i n}$. | $\mathbf{A}_{\mathbf{2}}$ <br> $\mathbf{m a x}$. | $\mathbf{b}$ | $\mathbf{b}_{\mathbf{1}}$ | $\mathbf{c}$ | $\mathbf{D}^{(1)}$ | $\mathbf{E}^{(1)}$ | $\mathbf{e}$ | $\mathbf{e}_{\mathbf{1}}$ | $\mathbf{L}$ | $\mathbf{M}_{\mathbf{E}}$ | $\mathbf{M}_{\mathbf{H}}$ | $\mathbf{w}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 4.70 | 0.38 | 3.94 | 1.63 <br> 1.14 | 0.56 <br> $\mathbf{m a x}$ |  |  |  |  |  |  |  |  |  |
| inches | 0.43 | 0.36 <br> 0.25 | 31.9 <br> 31.5 | 6.73 <br> 6.48 | 2.54 | 7.62 | 3.51 <br> 3.05 | 8.13 <br> 7.62 | 10.03 <br> 7.62 | 0.25 | 2.05 |  |  |  |

Note

1. Plastic or metal protrusions of 0.01 inches maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | EIAJ |  |  |
| SOT222-1 |  | MS-001AF |  | $\square$ ( | 95-03-11 |


detail X


DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | $\begin{gathered} \mathrm{A} \\ \text { max. } \end{gathered}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $\mathrm{D}^{(1)}$ | $E^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $L_{p}$ | Q | v | w | y | $z^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 2.65 | $\begin{aligned} & 0.30 \\ & 0.10 \end{aligned}$ | $\begin{aligned} & 2.45 \\ & 2.25 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.49 \\ & 0.36 \end{aligned}$ | $\begin{aligned} & 0.32 \\ & 0.23 \end{aligned}$ | $\begin{aligned} & 15.6 \\ & 15.2 \end{aligned}$ | $\begin{aligned} & 7.6 \\ & 7.4 \end{aligned}$ | 1.27 | $\begin{aligned} & 10.65 \\ & 10.00 \end{aligned}$ | 1.4 | $\begin{aligned} & 1.1 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 1.1 \\ & 1.0 \end{aligned}$ | 0.25 | 0.25 | 0.1 | 0.9 0.4 | $\begin{aligned} & 8^{0} \\ & 0^{\circ} \end{aligned}$ |
| inches | 0.10 | $\begin{aligned} & 0.012 \\ & 0.004 \end{aligned}$ | $\begin{aligned} & 0.096 \\ & 0.089 \end{aligned}$ | 0.01 | $\begin{aligned} & 0.019 \\ & 0.014 \end{aligned}$ | $\begin{aligned} & 0.013 \\ & 0.009 \end{aligned}$ | $\begin{aligned} & 0.61 \\ & 0.60 \end{aligned}$ | $\begin{aligned} & 0.30 \\ & 0.29 \end{aligned}$ | 0.050 | $\begin{aligned} & 0.419 \\ & 0.394 \end{aligned}$ | 0.055 | $\begin{aligned} & 0.043 \\ & 0.016 \end{aligned}$ | $\begin{aligned} & 0.043 \\ & 0.039 \end{aligned}$ | 0.01 | 0.01 | 0.004 | $\begin{aligned} & 0.035 \\ & 0.016 \end{aligned}$ |  |

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | ISSUE DATE |  |  |  |  |
| SOT137-1 | IEC | JEDEC | EIAJ |  |  |

Data sheet status

| Data sheet <br> status | Product <br> status | Definition [1] |
| :--- | :--- | :--- |
| Objective <br> specification | Development | This data sheet contains the design target or goal specifications for product development. <br> Specification may change in any manner without notice. |
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[^0]:    $\mathrm{H}=$ High voltage level
    L = Low voltage level
    Z = High impedance "off" state
    X = Don't care

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    L = Low voltage level
    Z = High impedance "off" state
    $X=$ Don't care

